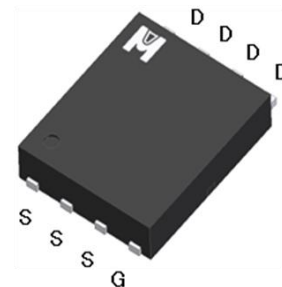
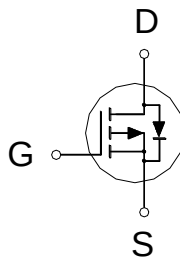


P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	-20V
$R_{DS(on)} (MAX.)$	$3.2m\Omega$
I_D	-100A



UIS, Rg 100% Tested

RoHS & Halogen Free & TSCA Compliant



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	± 12	V
Continuous Drain Current ¹	$T_C = 25^\circ\text{C}$	I_D	-100	A
	$T_C = 100^\circ\text{C}$		-73	
Pulsed Drain Current ²		I_{DM}	-400	
Avalanche Current		I_{AS}	-100	
Avalanche Energy	$L = 0.1\text{mH}$, $I_D = -100\text{A}$, $R_G = 25\Omega$	E_{AS}	500	mJ
Repetitive Avalanche Energy ³	$L = 0.05\text{mH}$	E_{AR}	250	
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	69	W
	$T_C = 100^\circ\text{C}$		27	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

100% UIS testing in condition of $V_D = -15\text{V}$, $L = 0.1\text{mH}$, $V_G = -5\text{V}$, $I_L = -60\text{A}$, Rated $V_{DS} = -20\text{V}$ P-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		1.8	$^\circ\text{C} / \text{W}$
Junction-to-Ambient ⁴	$R_{\theta JA}$		50	

¹Pulse width limited by maximum junction temperature.

²Duty cycle $< 1\%$

³The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz.

Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

⁴Guarantee by Engineering test

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4	-0.6	-1.2	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±12V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16V, V _{GS} = 0V			-1	μA
		V _{DS} = -12V, V _{GS} = 0V, T _J = 125 °C			-10	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = -5V, V _{GS} = -4.5V	-100			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = -10V, I _D = -20A		2.4	2.7	mΩ
		V _{GS} = -4.5V, I _D = -20A		2.7	3.2	
		V _{GS} = -2.5V, I _D = -20A		3.4	4.1	
Forward Transconductance ¹	g _{fs}	V _{DS} = -5V, I _D = -20A		65		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -10V, f = 1MHz		11116		pF
Output Capacitance	C _{oss}			1303		
Reverse Transfer Capacitance	C _{rss}			592		
Gate Resistance	R _g	V _{GS} = 15mV, V _{DS} = 0V, f = 1MHz		3		Ω
Total Gate Charge ^{1,2}	Q _g (V _{GS} =-10V)	V _{DS} = -10V, V _{GS} = -10V, I _D = -20A		202		nC
	Q _g (V _{GS} =-4.5V)			87		
Gate-Source Charge ^{1,2}	Q _{gs}			18		
Gate-Drain Charge ^{1,2}	Q _{gd}			16		
Turn-On Delay Time ^{1,2}	t _{d(on)}	V _{DS} = -10V, I _D = -5A, V _{GS} = -10V, R _G = 3Ω		20		nS
Rise Time ^{1,2}	t _r			55		
Turn-Off Delay Time ^{1,2}	t _{d(off)}			270		
Fall Time ^{1,2}	t _f			100		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _c = 25 °C)						
Continuous Current	I _s				-100	A
Pulsed Current ³	I _{SM}				-400	
Forward Voltage ¹	V _{SD}	I _F = -20A, V _{GS} = 0V			-1.2	V
Reverse Recovery Time	t _{rr}	I _F = -20A, dI _F /dt = 100A / μS		50		nS
Reverse Recovery Charge	Q _{rr}			180		nC

¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.



Ordering & Marking Information:

Device Name: EMF02P02H for EDFN 5 x 6



→ F02P02: Device Name

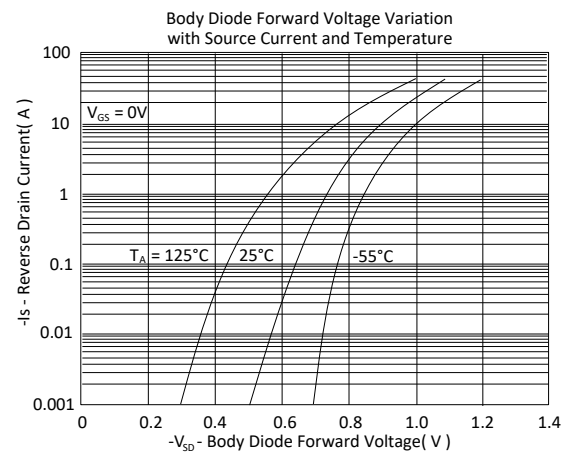
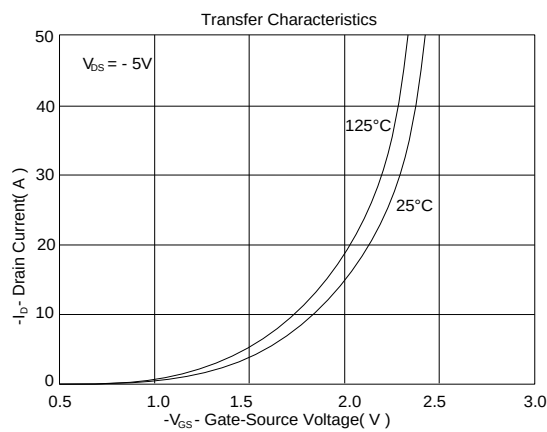
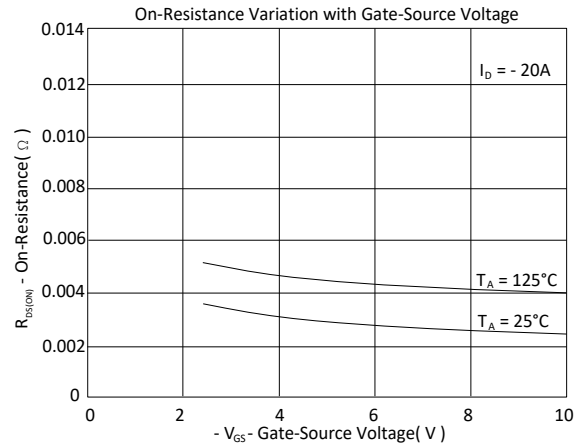
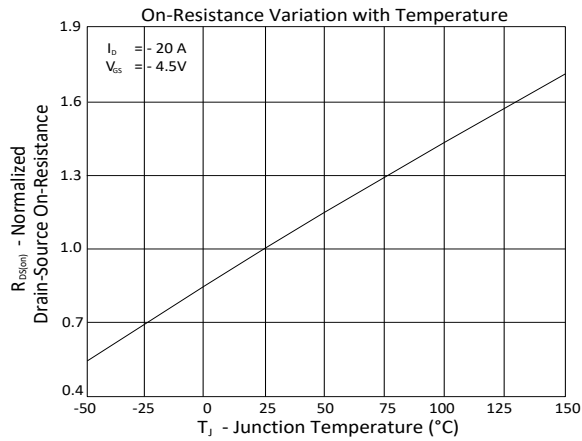
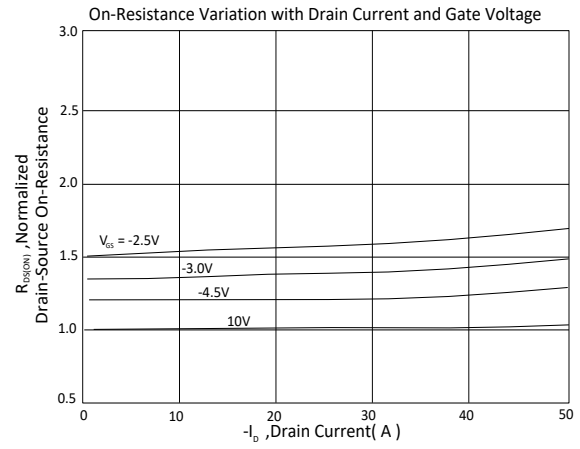
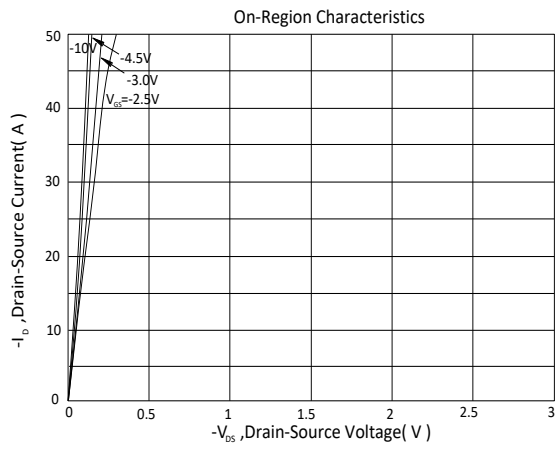
→ ABCDEFGH: Date Code

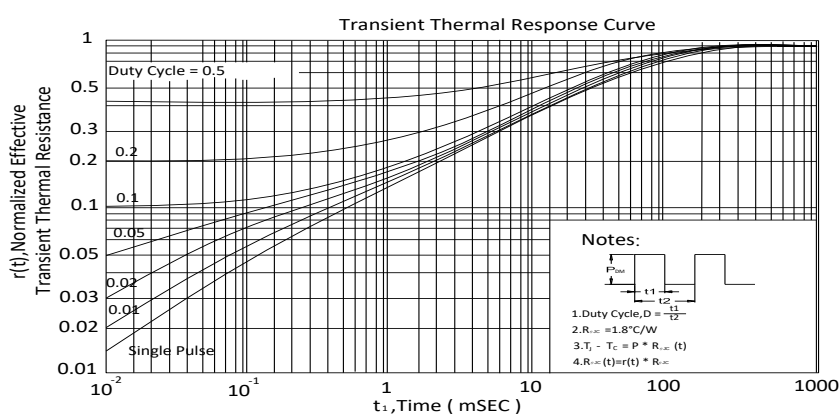
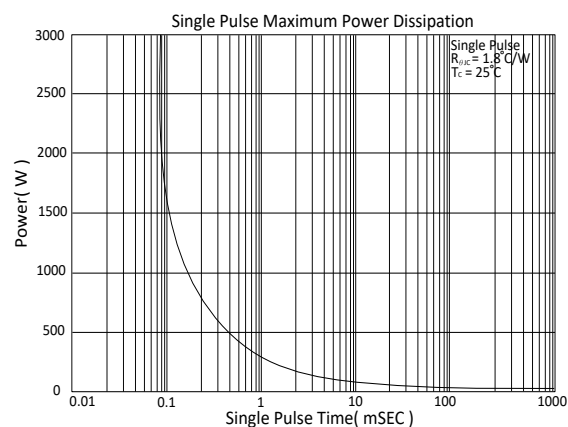
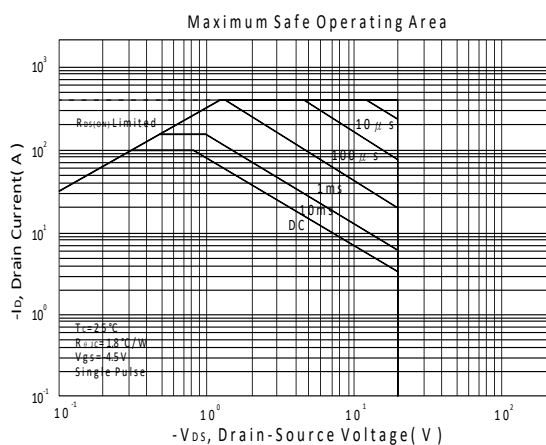
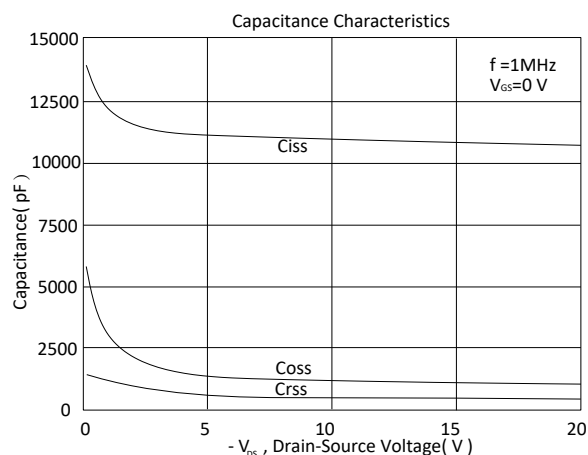
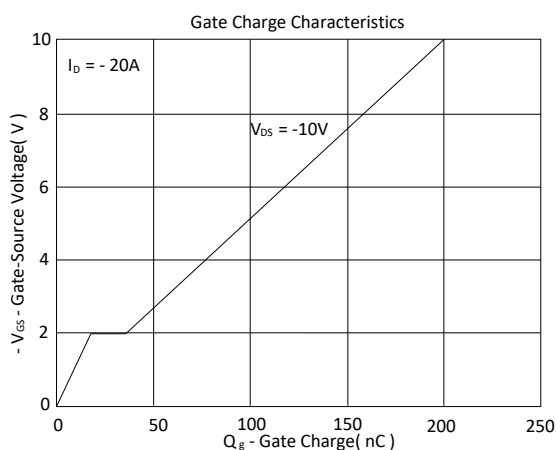
A: Assembly House

B: Year(A:2008 B:2009 C:2010....)

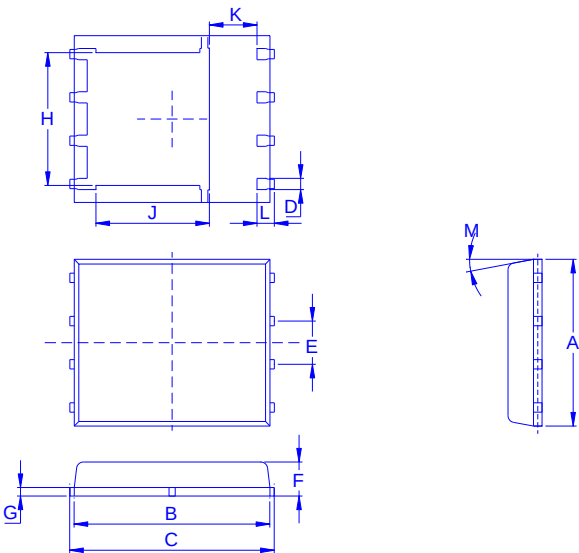
C: Month(A:01 B:02 C:03 D:04 E:05 F:06 G:07 H:08 I:09 J:10 K:11 L:12)

DEFG: Serial No.





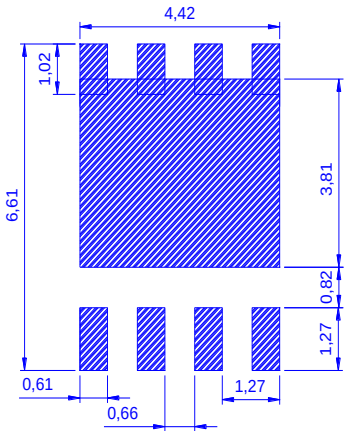
Outline Drawing



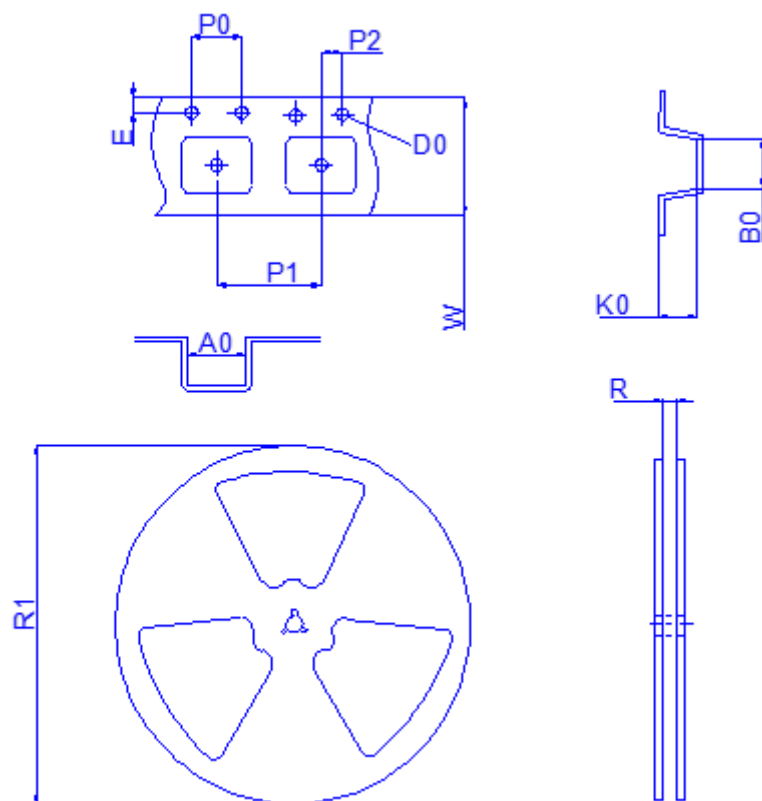
Dimension in mm

Dimension	A	B	C	D	E	F	G	H	J	K	L	M
Min	4.8	5.55	5.9	0.3	1.17	0.85	0.15	3.61	3.18	1	0.38	0°
Typ.	4.9	5.7	6	0.4	1.27	0.95	0.2	3.87	3.44	1.2	0.4	
Max	5.4	5.85	6.15	0.51	1.37	1.17	0.34	4.31	3.78	1.39	0.71	12°

Recommended minimum pads



◆ Tape&Reel Information:2500pcs/Reel(Dimension in millimeter)



Package	EDFN5X6
Reel	13"
Device orientation	FEED DIRECTION

Dimension in mm

Dimension	Carrier tape									Reel	
	A0	B0	D0	E	K0	P0	P1	P2	W	R	R1
Typ.	6.4	5.3	1.5	1.8	1.6	4	8	2	12	12.4	330
±	0.2	0.2	0.1	0.1	0.6	0.1	0.1	0.1	0.3	2	2